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APPLICATION NO.	FII	LING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/631,082	32 07/31/2003		Christoph Hechtl	TID-34165	2031	
23494	7590	03/02/2006		EXAM	EXAMINER	
TEXAS IN	STRUME	NTS INCORPO	YOUNG, CHR	YOUNG, CHRISTOPHER G		
P O BOX 655474, M/S 3999				ART UNIT	PAPER NUMBER	
DALLAS, TX 75265				1756		

DATE MAILED: 03/02/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)				
	10/631,082	HECHTL ET AL.				
Office Action Summary	Examiner	Art Unit				
	Christopher G. Young	1756				
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet with the c	orrespondence address				
A SHORTENED STATUTORY PERIOD FOR REPL' WHICHEVER IS LONGER, FROM THE MAILING DA  - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication.  - If NO period for reply is specified above, the maximum statutory period of  - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tim will apply and will expire SIX (6) MONTHS from , cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 14 D	<u>ecember 2005</u> .					
2a) This action is <b>FINAL</b> . 2b) ⊠ This	<i>,</i> —					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under E	Ex parte Quayle, 1935 C.D. 11, 45	53 O.G. 213.				
Disposition of Claims						
4) ☐ Claim(s) 1-14 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-14 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or	vn from consideration.					
Application Papers						
9) The specification is objected to by the Examine 10) The drawing(s) filed on 31 July 2003 is/are: a) Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Ex	☑ accepted or b)☐ objected to b drawing(s) be held in abeyance. See ion is required if the drawing(s) is obj	e 37 CFR 1.85(a). ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of:  1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the prior application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in Application ity documents have been received (PCT Rule 17.2(a)).	on No ed in this National Stage				
Attachment(s)  1)   Notice of References Cited (PTO-892)	4) Interview Summary	(PTO-413)				
Notice of Draftsperson's Patent Drawing Review (PTO-948)  Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper No(s)/Mail Da					

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#### **DETAILED ACTION**

### Response to Arguments

1. Applicant's arguments with respect to claims 1-14 have been considered but are moot in view of the new ground(s) of rejection.

## Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

3. Claims 1-14 are rejected under 35 U.S.C. 102(b) as being anticipated by Johnson, US Patent Number 6,426,168.

The instant application claims are drawn to a method of inspecting a mask comprising the steps: patterning a semiconductor material with a reference mask, patterning the semiconductor material with the mask as the inspection item, inspecting both patterns on the semiconductor material by means of an apparatus suitable for inspecting the semiconductor material, and comparing the pattern generated by the inspection item mask to the pattern generated by the reference mask to detect deviations in the inspection item mask from the reference mask.

The prior art reference describes, teaches and suggests the claimed invention by describing a method of inspecting photo masks by patterning at least one image in a first region of a substrate using a first photo mask, patterning at least one second image in a second region of the substrate using a second photo mask, wherein the first and second regions are substantially near one another. Comparing the first and second images to determine if the first photo mask forms a pattern substantially similar to the image formed by the second mask. Column 3, lines 31-60 provide a more detailed description. Here it is taught that a wafer 100 is transported to a develop module 220

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within the processing unit 200 (FIG. 7), where both the first and second resists 114, 118 within the first and second regions 116, 122, respectively, are developed to remove exposed material (in the event a positive photoresist is used), or to remove the unexposed material (in the event a negative photoresist is used). Following the resist develop, the wafer 100 is removed from the photo-processing unit 200, and transported to an inspection system. Therein the first image 130 formed within the first region 116 using Mask-1 is compared to the second image 132 formed within the second region 122 using Mask-2. For example, the two images 130, 132 patterned side-by-side on the wafer 100, are compared using an image comparison system or pattern comparison tool, such as a KLA 2135.TM.

The existence of defects within the second region 122 indicates differences between Mask-1 and Mask-2, wherein Mask-1 is a production worthy control mask and Mask-2 is a new mask. "Defect" refers to a difference in the printed image formed by Mask-2 as compared with the printed image formed by Mask-1, such as a feature having a different size and/or shape, the absence of an image, the appearance of an additional image, etc. Therefore, the existence of defects within the second region 122 indicates that Mask-2 is defective, and cannot be used to replace Mask-1 in semiconductor production. If no defects are found in the second region 122 Mask-2 may be used to replace Mask-1 in semiconductor production.

These teachings clearly show a mask inspection method where a reference pattern is formed and compared to an inspected pattern as claimed.

#### Conclusion

4. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Christopher G. Young whose telephone number is 571-272-1394. The examiner can normally be reached on Monday-Friday.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Mark Huff can be reached on 571-272-1385. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

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Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Christopher G. Young Primary Examiner

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